



Thick Film Resistor Networks, Dual-In-Line Small Outline Molded Dip, 01, 03, 05 Schematics



FEATURES

- 0.110" [2.79 mm] maximum seated height
- Rugged, molded case construction
- 0.050" [1.27 mm] lead spacing
- Reduces total assembly costs
- Compatible with automatic surface mounting equipment
- Uniform performance characteristics
- Meets EIA PDP 100, SOGN-0003 outline dimensions
- Available in tube pack or tape and reel pack
- Lead (Pb)-free version is RoHS compliant



RoHS*
COMPLIANT

STANDARD ELECTRICAL SPECIFICATIONS

| GLOBAL MODEL | SCHEMATIC | RESISTOR CIRCUIT W @ 70°C | PACKAGE POWER W @ 70°C | TOLERANCE ± % | RESISTANCE RANGE Ω | OPERATING VOLTAGE VDC | TEMPERATURE COEFFICIENT ppm/°C |
|--------------|-----------|---------------------------|------------------------|---------------|--------------------|-----------------------|--------------------------------|
| SOGC16 | 01 | 0.1 | 1.6 | 2 (1, 5*) | 10-1M0 | 50 max | 100 |
| | 03 | 0.19 | 1.6 | 2 (1, 5*) | 10-1M0 | 50 max | 100 |
| | 05 | 0.1 | 1.6 | 2 (5*) | 10-1M0 | 50 max | 100 |
| SOGC20 | 01 | 0.1 | 2.0 | 2 (1, 5*) | 10-1M0 | 50 max | 100 |
| | 03 | 0.19 | 2.0 | 2 (1, 5*) | 10-1M0 | 50 max | 100 |
| | 05 | 0.1 | 2.0 | 2 (5*) | 10-1M0 | 50 max | 100 |

* Tolerances in brackets available upon request.
• 100 milliohm maximum on zero ohm jumper

GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: SOGC200310K0GDC (preferred part numbering format)

S O G C 2 0 0 3 1 0 K 0 G D C

| GLOBAL MODEL | PIN COUNT | SCHEMATIC | RESISTANCE VALUE | TOLERANCE CODE | PACKAGING | SPECIAL |
|--------------|-----------|--|---|---|---|---|
| SOGC | 16 20 | 01 = Bussed 03 = Isolated 00 = Special | R = Decimal K = Thousand M = Million 10R0 = 10 Ω 680K = 680 KΩ 1M00 = 1.0 MΩ | F = ± 1% G = ± 2% J = ± 5% S = Special Z = 0 Ω Jumper | EJ = Lead Free, Tube EA = Lead (Pb)-free, Tape & Reel DC = Tin/Lead, Tube RZ = Tin/Lead, Tape & Reel | Blank = Standard (Dash Number) (up to 3 digits) From 1-999 as applicable |

Historical Part Number example: SOGC2003103G (will continue to be accepted)

SOGC 20 03 103 G D02
HISTORICAL MODEL PIN COUNT SCHEMATIC RESISTANCE VALUE TOLERANCE CODE PACKAGING

New Global Part Numbering: SOGC1605131AGRZ (preferred part numbering format)

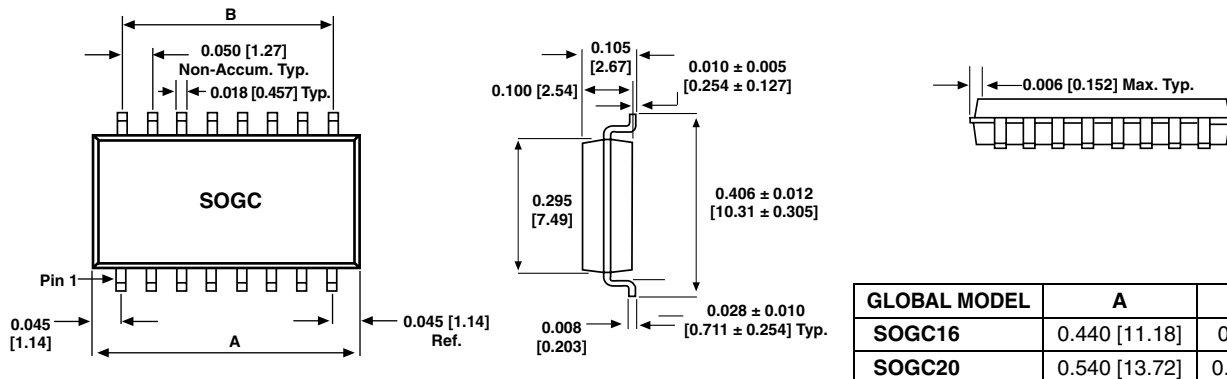
S O G C 1 6 0 5 1 3 1 A G R Z

| GLOBAL MODEL | PIN COUNT | SCHEMATIC | RESISTANCE VALUE | TOLERANCE CODE | PACKAGING | SPECIAL |
|--------------|-----------|----------------------|--|----------------------------------|---|---|
| SOGC | 16 20 | 05 = Dual Terminator | 3 digit Impedance code, followed by Alpha modifier (see Impedance Codes table) | F = ± 1% G = ± 2% J = ± 5% | EJ = Lead Free, Tube EA = Lead (Pb)-free, Tape & Reel DC = Tin/Lead, Tube RZ = Tin/Lead, Tape & Reel | Blank = Standard (Dash Number) (up to 3 digits) From 1-999 as applicable |

Historical Part Number example: SOGC1605221331G (will continue to be accepted)

SOGC 16 05 221 331 G R61
HISTORICAL MODEL PIN COUNT SCHEMATIC RESISTANCE VALUE 1 RESISTANCE VALUE 2 TOLERANCE CODE PACKAGING

* Pb containing terminations are not RoHS compliant, exemptions may apply

DIMENSIONS in inches [millimeters]


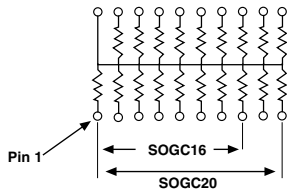
| TECHNICAL SPECIFICATIONS | | | |
|---------------------------------------|--------|---------------|--------|
| PARAMETER | UNIT | SOGC16 | SOGC20 |
| Package Power Rating (max. at + 70°C) | W | 1.6 | 2.0 |
| TC Tracking (- 55°C to + 125°C) | ppm/°C | ± 50 | |
| Voltage Coefficient of Resistance: | ppm/V | < 50 typical | |
| Maximum Operating Voltage: | VDC | 50 | |
| Operating Temperature Range: | °C | - 55 to + 125 | |
| Storage Temperature Range: | °C | - 55 to + 150 | |

| MECHANICAL SPECIFICATIONS | |
|------------------------------------|---|
| Marking: | Model number, schematic number, value tolerance, pin 1 indicator, date code |
| Marking Resistance to Solvents: | Permanency testing per MIL-STD-202, Method 215 |
| Maximum Solder Reflow Temperature: | + 255 °C |
| Solderability: | Per MIL-STD-202, Method 208E |
| Terminals: | Copper alloy. Solder dipped terminal |
| Body: | Molded epoxy |

| IMPEDANCE CODES | | | | | |
|-----------------|--------------------|--------------------|------|--------------------|--------------------|
| CODE | R ₁ (Ω) | R ₂ (Ω) | CODE | R ₁ (Ω) | R ₂ (Ω) |
| 500B | 82 | 130 | 141A | 270 | 270 |
| 750B | 120 | 200 | 181A | 330 | 390 |
| 800C | 130 | 210 | 191A | 330 | 470 |
| 990A | 160 | 260 | 221B | 330 | 680 |
| 101C | 180 | 240 | 281B | 560 | 560 |
| 111C | 180 | 270 | 381B | 560 | 1.2K |
| 121B | 180 | 390 | 501C | 620 | 2.7K |
| 121C | 220 | 270 | 102A | 1.5K | 3.3K |
| 131A | 220 | 330 | 202B | 3K | 6.2K |

CIRCUIT APPLICATIONS

01 Schematic

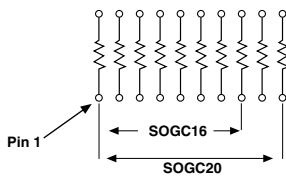


15 or 19 resistors with one pin common

The SOGCxx01 circuit provides a choice of 15 or 19 nominally equal resistors, each connected between a common lead (16 or 20) and a discrete PC board pin. Commonly used in the following applications:

- MOS/ROM Pull-up/Pull-down
- Open Collector Pull-up
- "Wired OR" Pull-up
- Power Driven Pull-up
- TTL Input Pull-down
- Digital Pulse Squaring
- TTL Unused Gate Pull-up
- High Speed Parallels Pull-up

03 Schematic

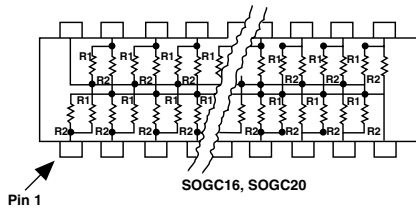


8 or 10 isolated resistors

The SOGCxx03 circuit provides a choice of 8 or 10 nominally equal resistors with each resistor isolated from all others and wired directly across. Commonly used in the following applications:

- "Wired OR" Pull-up
- Power Driven Pull-up
- Powergate Pull-up
- Line Termination
- Long-line Impedance Balancing
- LED Current Limiting
- ECL Output Pull-down
- TTL Input Pull-down

05 Schematic



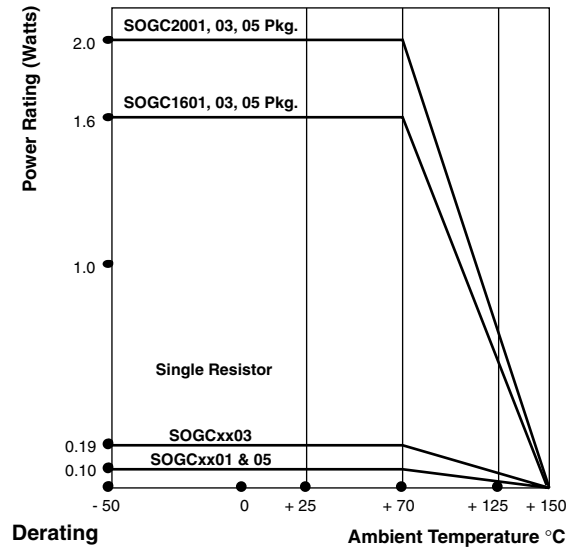
TTL dual-line terminator; pulse squaring, 14 or 18 pairs of resistors

(R₁ Resistors are common to leads 16 or 20)

(R₂ Resistors are common to leads 8 or 10)

The SOGCxx05 circuit contains 14 or 18 pairs of resistors. Each pair is connected between ground and a common line. The junctions of these resistor pairs are connected to the input leads.

The 05 circuits are designed for TTL dual-line termination and pulse squaring.



| PERFORMANCE | |
|---------------------------------|---|
| TEST | MAX. ΔR (TYPICAL TEST LOTS) |
| Power Conditioning | ± 0.50 % ΔR |
| Thermal Shock | ± 0.50 % ΔR |
| Short Time Overload | ± 0.25 % ΔR |
| Low Temperature Operation | ± 0.25 % ΔR |
| Moisture Resistance | ± 0.50 % ΔR |
| Resistance to Soldering Heat | ± 0.25 % ΔR |
| Shock | ± 0.25 % ΔR |
| Vibration | ± 0.25 % ΔR |
| Load Life | ± 0.50 % ΔR |
| Terminal Strength | ± 0.25 % ΔR |
| Insulation Resistance | 10 000 Megohm (minimum) |
| Dielectric Withstanding Voltage | No evidence of arcing or damage (200 V RMS for 1 minute) |



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